

General Description

These N-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

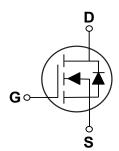
BV _{DSS}	R _{DS(ON)}	I _D
600 V	380 mΩ	9.1 A

Features

- $\cdot R_{DS(ON)} \le 380 m \Omega @V_{GS} = 10V$
- · Improved dv/dt Capability
- · Fast Switching
- · Green Device Available

TO-220F Pin Configuration





Applications

- LED Power Supply
- · Electronic Ballast
- High Frequency Switching Mode Power Supply

Absolute Maximum Ratings T_C=25°C unless otherwise noted **Symbol Parameter** Rating Units V_{DS} Drain-Source Voltage 600 V V_{GS} Gate-Source Voltage ±30 V 9.1 I_D Drain Current – Continuous (T_C=25°C) Α I_{DM} Drain Current - Pulsed (NOTE 1) 33 EAS Single Pulse Avalanche Energy (NOTE 2) 280 mJ P_{D} W Power Dissipation (T_C=25°C) 32 T_J Operating Junction Temperature Range -55 to 150 ٥С Storage Temperature Range -55 to 150 T_{STG} ٥С Marking Code NAA380

Thermal Characteristics					
Symbol	Parameter	Rating	Unit		
$R_{\theta JA}$	Thermal Resistance Junction to Ambient	80	°C/W		
$R_{ heta JC}$	Thermal Resistance Junction to Case	3.92	°C/W		





Electrical Characteristics (T_J=25°C, unless otherwise noted)

Off Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V_{GS} =0V , I_D =250uA	600			٧
I _{DSS}	Drain-Source Leakage Current	V _{DS} =600V , V _{GS} =0V			10	uA
I _{GSS}	Gate-Source Leakage Current	V_{GS} =±30V , V_{DS} =0V			±100	nA

On Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =10V , I _D =7A			380	mΩ
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS}=V_{DS}$, $I_D=250uA$	2.5		4.0	V
gfs	Forward Transconductance	V_{DS} =20V , I_{D} =7A		8.1		S

Dynamic and switching Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Q_g	Total Gate Charge	V 500V V 40V L 44A		25		
Q_{gs}	Gate-Source Charge	V _{DS} =520V , V _{GS} =10V , I _D =11A -(NOTE 3 \ 4)		6		nC
Q_{gd}	Gate-Drain Charge	(NOTE 3 \ 4)		8.7		
$T_{d(on)}$	Turn-On Delay Time	V_{DD} =380V , R_{G} =6.8 Ω , I_{D} =5.5A , V_{GS} =10V (NOTE 3 $^{\circ}$ 4)		9		
T _r	Rise Time			4		nS
$T_{d(off)}$	Turn-Off Delay Time			41		113
T_f	Fall Time			4.6		
C _{iss}	Input Capacitance	V _{DS} =50V , V _{GS} =0V , F=1MHz		1035		
C_{oss}	Output Capacitance			89		pF
C_{rss}	Reverse Transfer Capacitance			4.5		
R_g	Gate Resistance	V _{DS} =0V , V _{GS} =0V , F=1MHz		2.1		Ω

Drain-Source Diode Characteristics and Ratings

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Is	Continuous Body Diode Current				9.1	Α
I _{SM}	Pulsed Diode Forward Current				29	Α
V_{SD}	Diode Forward Voltage	V_{GS} =0V , I_{S} =9A			1.2	V
t _{rr}	Reverse Recovery Time	V _{GS} =0V , I _E =I _S , dI _E /dt=100A/us		247		nS
Q_{rr}	Reverse Recovery Charge	V _{GS} -0V, I _F -I _S , dI _F /dt-100A/dS		2.4		uC

NOTES

- 1. Repetitive Rating: Pulsed width limited by maximum junction temperature.
- 2. V_{GS} =10V, V_{DD} =50V, R_{G} =25 Ω .
- 3. The data tested by pulsed , pulse width \leq 300us , duty cycle \leq 2%.
- 4. Essentially independent of operating temperature.





Characteristics Curves

FIG. 1- Power Dissipation

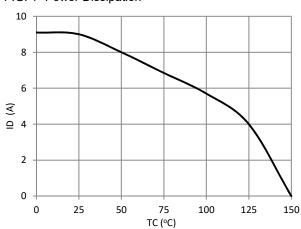


FIG. 2-BV_{DSS} (Normalized) vs. T_J

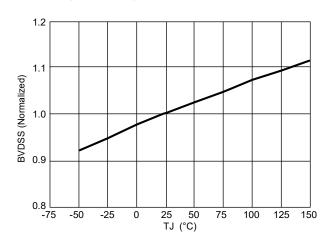


FIG. 3- $R_{DS(ON)}$ vs. I_D

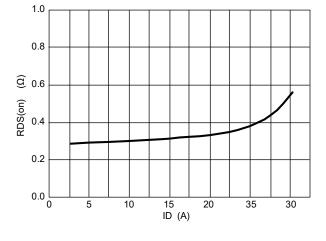


FIG. 4- Gate Charge Characteristics

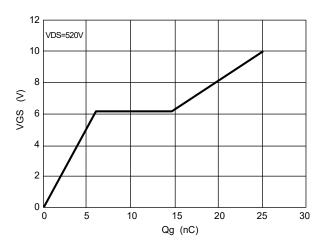


FIG. 5- Safe Operation Area

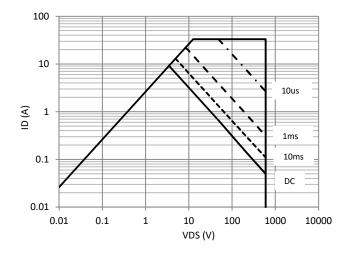
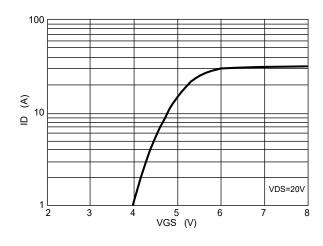


FIG. 6- Transfer Characteristics







Characteristics Curves

FIG. 7- Switching Time Waveform

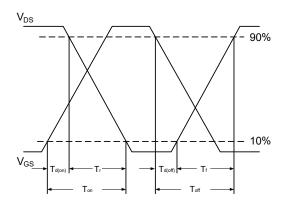
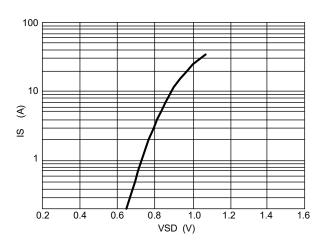
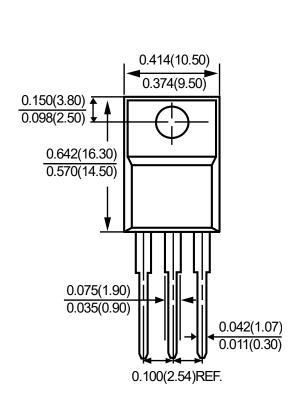
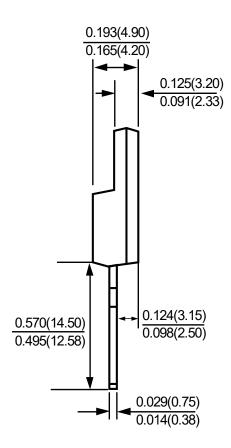


FIG. 8- Diode Forward Characteristics



Package Outline Dimensions





TO-220FDimensions in inches and (millimeters)





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